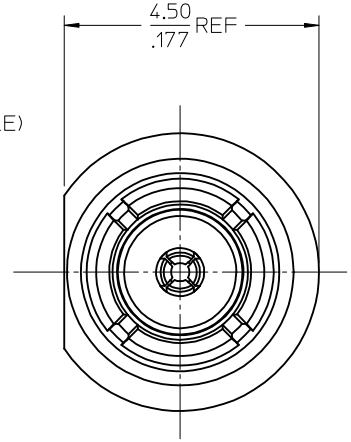
MATERIALS AND FINISHES

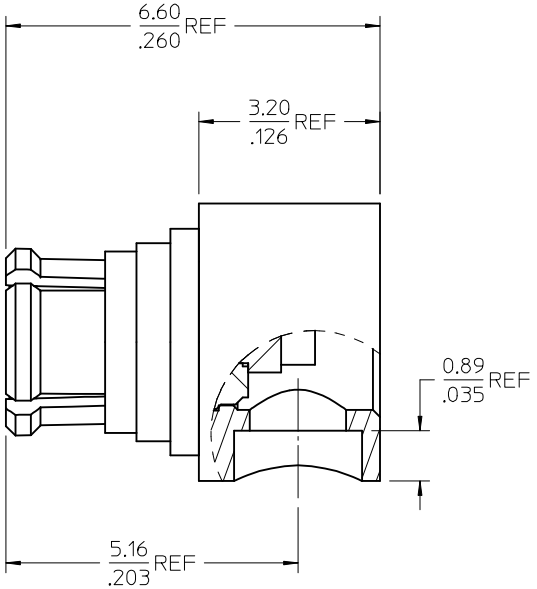
BODY, CONTACT: BERYLLIUM COPPER
PLATED GOLD/NICKEL (SEE TABLE)

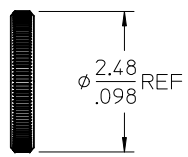
INSULATOR: PTFE

EMI RING, CAP: BRASS
PLATED GOLD/NICKEL (SEE TABLE)

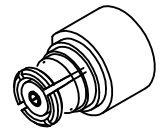
VSWR 1.25 MAX 0 - 18 GHz

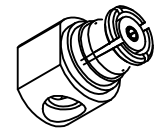






CAP





AS-89675-460	ASSEMBLY INSTRUCTIONS
PS-89675-3320	PRODUCT SPECIFICATION
MIL-STD-348A, FIG. 326.1	INTERFACE
SPECIFICATION	DESCRIPTION

73415-3035	MOLEX INTERNAL USE ONLY NOT AVAILABLE	N/A	N/A	N/A
73415-3034	TRAY PACK	30µ-in/100µ-in MIN	30µ-in/100µ-in MIN	30µ-in/100µ-in MIN
73415-3033	TRAY PACK	8µ-in/80µ-in MIN	8µ-in/80µ-in MIN	8µ-in/80µ-in MIN
73415-3032	PLACE 73415-3030 INTO SMALL TRAY	30µ-in/100µ-in MIN	50µ-in/100µ-in MIN	30µ-in/100µ-in MIN
73415-3031	1 COMPLETE ASSEMBLY 73415-3030 PER BAG	30µ-in/100µ-in MIN	50µ-in/100µ-in MIN	30µ-in/100µ-in MIN
73415-3030	TRAY PACK	30µ-in/100µ-in MIN	50µ-in/100µ-in MIN	30µ-in/100µ-in MIN
PART NO.	PACKAGING	GOLD/NICKEL	GOLD/NICKEL	GOLD/NICKEL
		BODY	CONTACT	CAP

CHG: ADDED PLATING SPEC., VSWR AND PS. DELETED CABLE CUT VIEW
EC NO: URF2016-0818 2016/06/01
DRWN:BSHAH 2016/06/01
CH'KD:SSS
APPR:AROBERTSON 2016/06/06
DESCRIPTION
B1
REV

QUALITY SYMBOLS
E =0
E =0
E =0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± 0.005
2 PLACES	± 0.13	± 0.010
1 PLACE	± 0.25	± ---
0 PLACE	±	±

ANGULAR ± 2 °

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: MM/IN
SCALE: 15:1
DESIGN UNITS: METRIC
THIRD ANGLE PROJECTION

	DRAWN BY	DATE
	SSS	2001/03/29
	CHECKED BY	DATE
	TEF	2001/03/29
	APPROVED BY	DATE
	GMH	2001/03/29

TITLE: SMP JACK, R/A FOR 086 CABLE, 50 OHM SMP-JC

molex

MATERIAL NO.: SEE TABLE
DOCUMENT NO.: SD-73415-303
SHEET NO.: 1 OF 1
SIZE: C

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